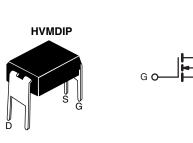


### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	0.54			
Q <sub>g</sub> (Max.) (nC)	8.3				
Q <sub>gs</sub> (nC)	2.3				
Q <sub>gd</sub> (nC)	3.8				
Configuration	Single				



N-Channel MOSFET

### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- 175 °C Operating Temperature
- Fast Switching and Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD110PbF
	SiHFD110-E3
SnPb	IRFD110
	SiHFD110

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	100	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 25 °C	1-	1.0	А	
Continuous Drain Current		T <sub>A</sub> = 100 °C	I <sub>D</sub>	0.71		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	8.0	7	
Linear Derating Factor				0.0083	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	140	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	1.0	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum Power Dissipation T <sub>A</sub> = 25 °C		P <sub>D</sub>	1.3	W		
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 52 \,^{\circ}\text{MH}$ ,  $R_g = 25 \,^{\circ}\Omega$ ,  $I_{AS} = 2.0 \,^{\circ}\text{A}$  (see fig. 12).
- c.  $I_{SD} \le 5.6$  A,  $dI/dt \le 75$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFD110, SiHFD110

# Vishay Siliconix



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	$R_{thJA}$	-	120	°C/W		

PARAMETER	nless otherw SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				L			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		100	-	-	V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
	I <sub>DSS</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 80 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.60 A <sup>b</sup>	-	-	0.54	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 0.60 A <sup>b</sup>		-	-	S
Dynamic				1			
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,		-	180	-	
Output Capacitance	Coss		$V_{DS} = 25 \text{ V},$	-	81	-	рF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	f = 1.0 MHz, see fig. 5		15	-	1
Total Gate Charge	Qg			-	-	8.3	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 5.6 A, V <sub>DS</sub> = 80 V, see fig. 6 and 13 <sup>b</sup>	-	-	2.3	nC
Gate-Drain Charge	Q <sub>gd</sub>	1	See fig. 6 and 16	-	-	3.8	
Turn-On Delay Time	t <sub>d(on)</sub>			-	6.9	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 50 V, $I_D$ = 5.6 A, $R_g$ = 24 $\Omega$ , $R_D$ = 8.4 $\Omega$ , see fig. 10 <sup>b</sup>		-	16	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	9.4	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25")	Between lead, 6 mm (0.25") from		4.0	-	-11
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6.0	-	nH
Drain-Source Body Diode Characteristic	s				l	·	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.0	_
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	8.0	A
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 1.0  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 05 00 1	E C A 41/4+ 400 A / b	-	100	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 5.6  \text{A},  \text{dI/dt} = 100  \text{A/µs}^{\text{b}}$		-	0.44	0.88	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

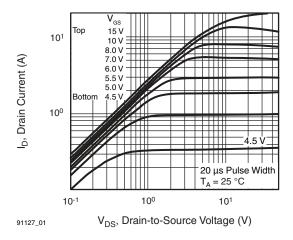


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 25 °C

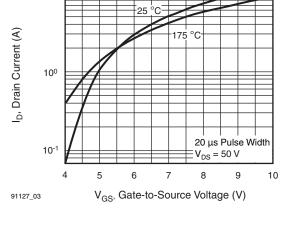


Fig. 3 - Typical Transfer Characteristics

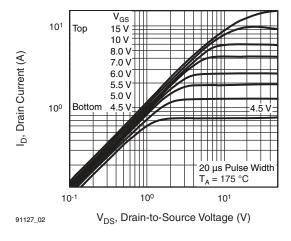


Fig. 2 - Typical Output Characteristics,  $T_A$  = 175 °C

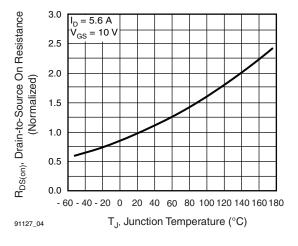


Fig. 4 - Normalized On-Resistance vs. Temperature



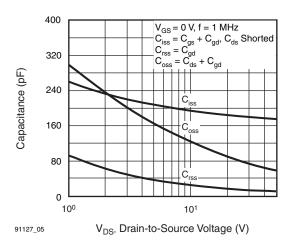


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

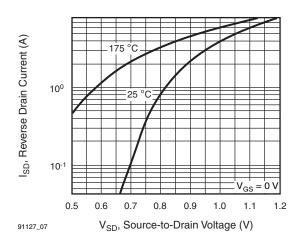


Fig. 7 - Typical Source-Drain Diode Forward Voltage

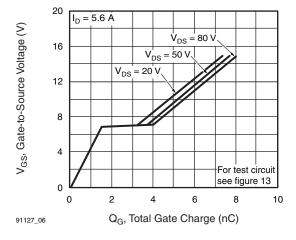


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

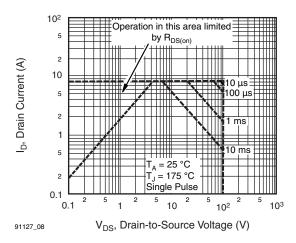


Fig. 8 - Maximum Safe Operating Area





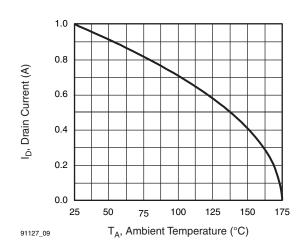


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

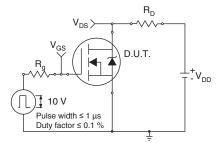


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

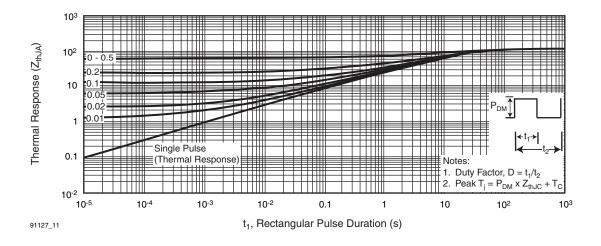


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



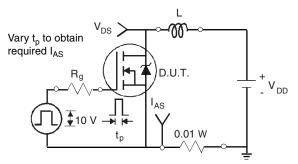


Fig. 12a - Unclamped Inductive Test Circuit

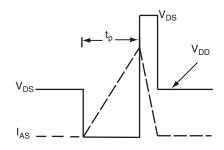


Fig. 12b - Unclamped Inductive Waveforms

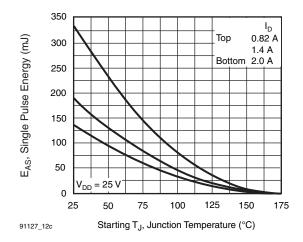


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

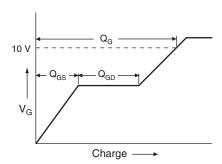


Fig. 13a - Basic Gate Charge Waveform

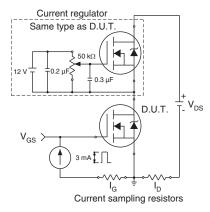
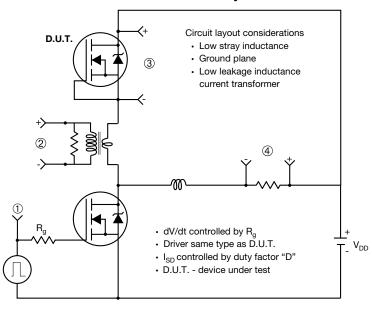


Fig. 13b - Gate Charge Test Circuit





### Peak Diode Recovery dV/dt Test Circuit



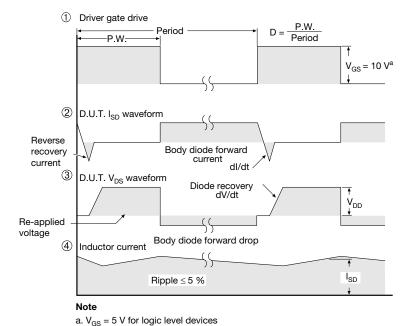
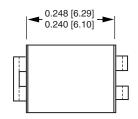
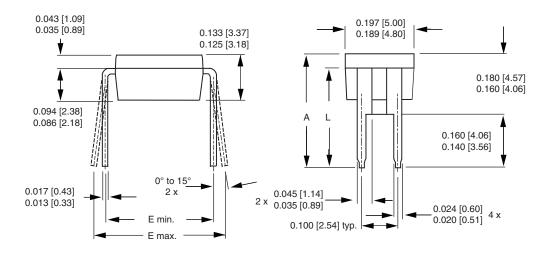


Fig. 14 - For N-Channel

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### **HVM DIP** (High voltage)





	INCHES		MILLIMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36

ECN: X10-0386-Rev. B, 06-Sep-10

DWG: 5974

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 Revision: 06-Sep-10



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